

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT6059688

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	SANDOR FARKAS	04/02/2020
	BHYRAV MUTNURY	04/10/2020
RECEIVING PARTY DATA		
Name:	DELL PRODUCTS, LP	
Street Address:	ONE DELL WAY	
City:	ROUND ROCK	
State/Country:	TEXAS	
Postal Code:	78682	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	16847791
CORRESPONDENCE DATA		
Fax Number:	(512)439-7199	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	512-439-7100	
Email:	docketing@larsonnewman.com	
Correspondent Name:	LARSON NEWMAN, LP (DELL)	
Address Line 1:	8200 N. MOPAC EXPY., SUITE 280	
Address Line 4:	AUSTIN, TEXAS 78759	
ATTORNEY DOCKET NUMBER:	DC-118927	
NAME OF SUBMITTER:	TIMOTHY G. NEWMAN	
SIGNATURE:	/timothy g newman/	
DATE SIGNED:	04/14/2020	
Total Attachments: 3		
source=Assignment_DC-118927#page1.tif		
source=Assignment_DC-118927#page2.tif		
source=Assignment_DC-118927#page3.tif		

ASSIGNMENT OF INVENTION

For good and valuable consideration, the receipt of which is hereby acknowledged,
I, an Assignor named below,

Sandor Farkas of **Round Rock, Texas, USA**
Bhyrav Mutnury of **Austin, Texas, USA**

hereby sell, assign and transfer to

ASSIGNEE: **DELL PRODUCTS, LP**
One Dell Way
Round Rock, Texas 78682

its successors, assigns and legal representatives, my entire right, title and interest throughout the world, including all rights to claim priority, in and to the invention disclosed in:

- ☒ U.S. Patent Application executed on or about the date of this Assignment,
- ☐ U.S. Patent Application executed on _____, or
- ☐ U.S. Provisional Application
- ☐ U.S. Application No.: _____, filed on _____
- ☐ International Application No.: PCT/_____, filed on _____

ENTITLED: **METHOD TO IMPROVE PCB TRACE CONDUCTIVITY AND SYSTEM THEREFOR**

("Invention") including without limitation, my entire right, title and interest in and to any and all United States and foreign applications (including international, regional and foreign national applications) for said Invention, including divisions, continuations, continuations-in-part, utility models, industrial designs, renewals, substitutes and extensions thereof, and in and to any and all patents, invention registrations, or other forms of protection ("Patents") of every country or region that may be granted or have been granted for said Invention, including any reissues and reexaminations thereof.


To comply with 37 C.F.R. § 3.21 for recording this Assignment, I authorize and request that the application number and filing date be inserted here, if not already shown above,
(_____/_____, filed _____) when they become known.

I authorize Assignee to apply for patents of foreign countries for said Invention, and to claim all rights of priority without further authorization from me.

I agree that, upon request and without further compensation, but at no expense to me, I and/or my legal representatives and assigns will do all lawful acts, including the execution of papers and the giving of testimony, that may be necessary or desirable for obtaining, sustaining, reissuing, or enforcing the Patents in the United States and throughout the world for said Invention, and for perfecting, recording, or maintaining the title of Assignee, its successors and assigns, to said Invention, said application, and any Patents granted for said Invention in the United States throughout the world.

I hereby covenant that no assignment, sale, license, agreement, or encumbrance has been or will be made or entered into that would conflict with this Assignment.

I authorize and request the Director of the United States Patent and Trademark Office and agencies, departments, or other similar offices and officials of all foreign countries to issue any Patents granted for said Invention, whether on said application or on any subsequently filed divisional, continuation, continuation-in-part, reexamination, reissue or other application, to Assignee, its successors and assigns, as the assignee of the entire interest in said Invention.

Executed on 4/2/2020 by 
Sandor Farkas

Executed on _____ by _____
Bhyrav Mutnury

I hereby covenant that no assignment, sale, license, agreement, or encumbrance has been or will be made or entered into that would conflict with this Assignment.

I authorize and request the Director of the United States Patent and Trademark Office and agencies, departments, or other similar offices and officials of all foreign countries to issue any Patents granted for said Invention, whether on said application or on any subsequently filed divisional, continuation, continuation-in-part, reexamination, reissue or other application, to Assignee, its successors and assigns, as the assignee of the entire interest in said Invention.

Executed on _____ by _____,
Sandor Farkas

Executed on 04/10/2020 by M. Bhyrav Mutnury,
Bhyrav Mutnury